

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Wood et al.

**Serial No.:** 10/799,258

**Filed:** March 12, 2004

**For:** METHOD FOR TESTING USING A  
UNIVERSAL WAFER CARRIER FOR  
WAFER LEVEL DIE BURN-IN (AS  
AMENDED)

**Confirmation No.:** 8225

**Examiner:** E. Karlsen

**Group Art Unit:** 2829

**Attorney Docket No.:** 2269-2825.13US  
(90-0051.15/US)

**Notice of Allowance Mailed:**

March 28, 2007

**VIA ELECTRONIC FILING**  
July 27, 2007

**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES  
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.  
Mail Stop 525  
8000 South Federal Way  
Boise, Idaho 83707-0006

2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



James R. Duzan  
Registration No. 28,393  
Attorney for Applicants  
TRASKBRITT  
P.O. Box 2550  
Salt Lake City, Utah 84110-2550  
Telephone: 801-532-1922

Date: July 27, 2007  
JRD/djp:lmh  
Document in ProLaw